



**THE DATASHEET OF  
SBR20U50SLP-13**



## Product Summary

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F max</sub> (V)	I <sub>R max</sub> (mA)
50	20	0.52	0.5

## Description and Applications

Packaged in the compact thermally efficient PowerDI5060-8 package, the DIODES™ SBR20U50SLP provides very low V<sub>F</sub> and excellent reverse leakage stability at high temperatures. It is ideal for use as a rectifier, freewheel diode or blocking diode in:

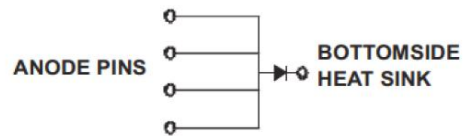
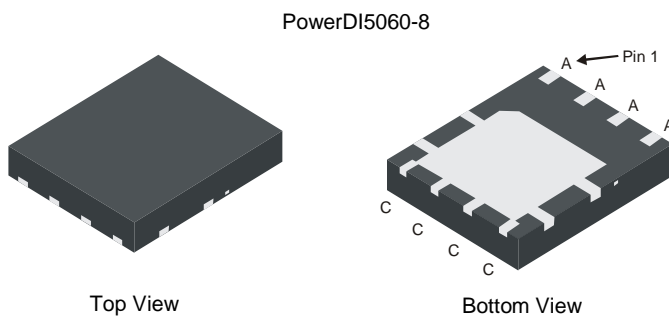
- DC-DC converters
- AC-DC adaptors

## Features and Benefits

- Patented SBR® Technology Provides Superior Avalanche Capability Versus Schottky Diodes, Ensuring More Rugged and Reliable End Applications
- Reduced Ultra-Low Forward Voltage Drop (V<sub>F</sub>); Better Efficiency and Cooler Operation
- Reduced High Temperature Reverse Leakage; Increased Reliability Against Thermal Runaway Failure in High Temperature Operation
- <1.1mm Package Profile – Ideal for Thin Applications
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free “Green” Device (Note 3)**
- **For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at <https://www.diodes.com/products/automotive/automotive-products/>.**
- **This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability. <https://www.diodes.com/quality/product-definitions/>**

## Mechanical Data

- Package: PowerDI®5060-8
- Package Material: Molded Plastic, “Green” Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 (Ⓔ)
- Polarity: See Below
- Weight: 0.097 grams (Approximate)



**Note: All four anode pins must be electrically connected at the printed circuit board.**

## Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
SBR20U50SLP-13	PowerDI5060-8	2,500	Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

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## Marking Information

PowerDI5060-8



⤴⤵ = Manufacturer's Marking  
 SBR20U50S = Product Type Marking Code  
 YYWW = Date Code Marking  
 YY = Last Two Digits of Year (ex: 22 = 2022)  
 WW = Week (01 to 53)

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
 For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	50	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>RM</sub>		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	V
Average Rectified Output Current	I <sub>O</sub>	20	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	100	A

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R <sub>θJA</sub>	30	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R <sub>θJC</sub>	5	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +125	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop (Note 6)	V <sub>F</sub>	—	—	0.48	V	I <sub>F</sub> = 10A, T <sub>J</sub> = +25°C
		—	0.46	0.52		I <sub>F</sub> = 20A, T <sub>J</sub> = +25°C
Leakage Current (Note 6)	I <sub>R</sub>	—	—	0.5	mA	V <sub>R</sub> = 50V, T <sub>J</sub> = +25°C
		—	—	100		V <sub>R</sub> = 50V, T <sub>J</sub> = +125°C
Reverse Recovery Time	t <sub>rr</sub>	—	57	—	ns	I <sub>F</sub> = 0.5A, I <sub>R</sub> = 1.0A I <sub>RR</sub> = 0.25A
Total Capacitance	C <sub>T</sub>	—	400	—	pF	V <sub>R</sub> = 40V, f = 1MHz

Notes: 5. Device mounted on FR4 substrate PC board with 10cm x 10cm copper pad.  
 6. Short duration pulse test used to minimize self-heating effect.

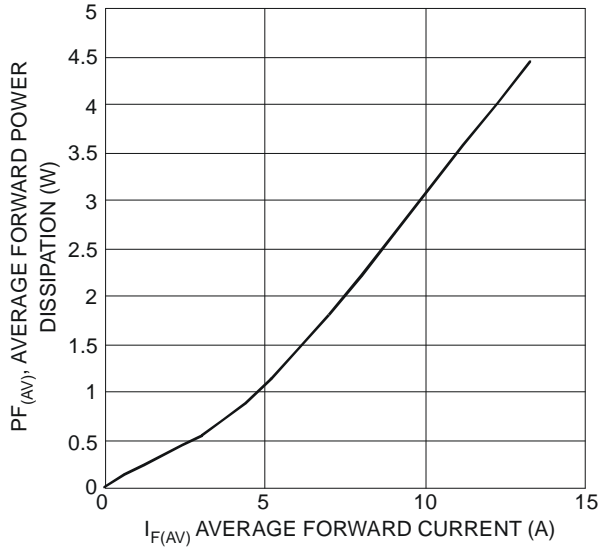


Figure 1 Forward Power Dissipation

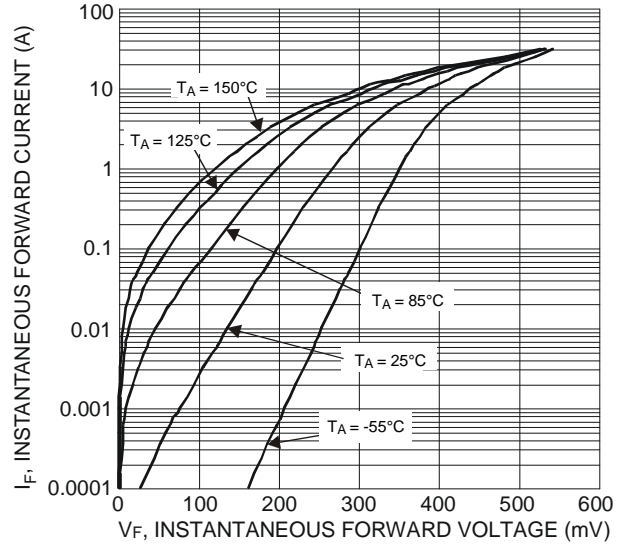


Figure 2 Typical Forward Characteristics

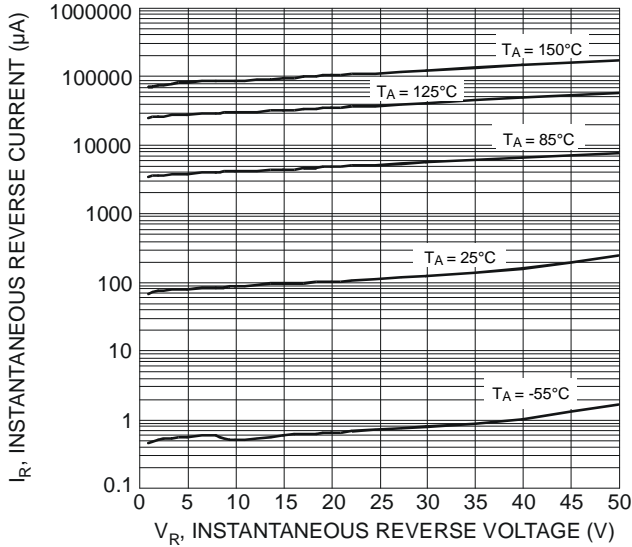


Figure 3 Typical Reverse Characteristics

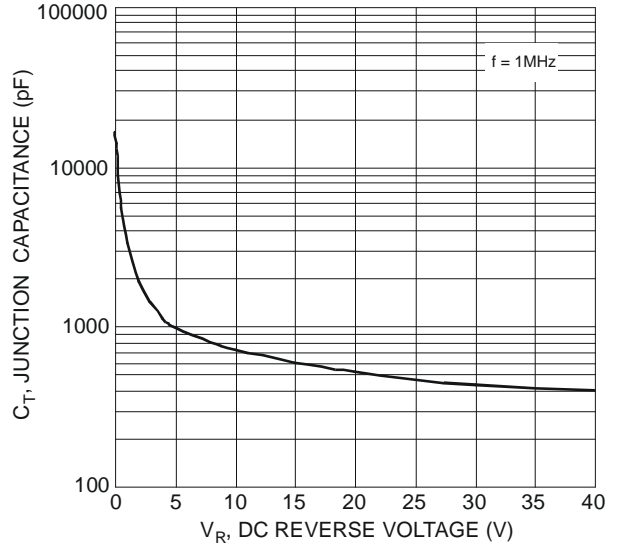


Figure 4 Typical Junction vs. Reverse Voltage

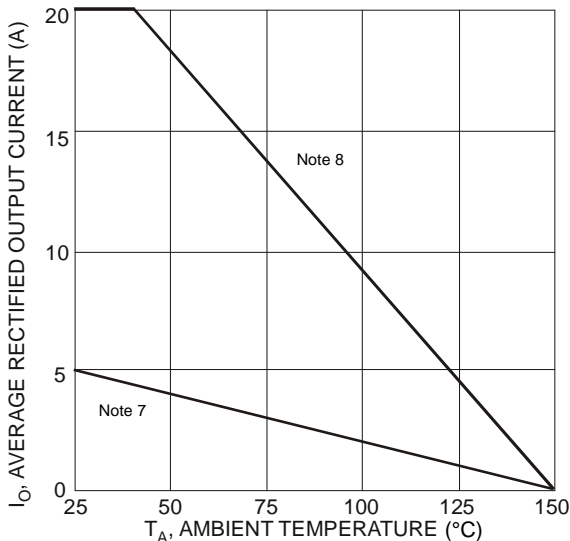


Figure 5 DC Forward Current Derating Curve

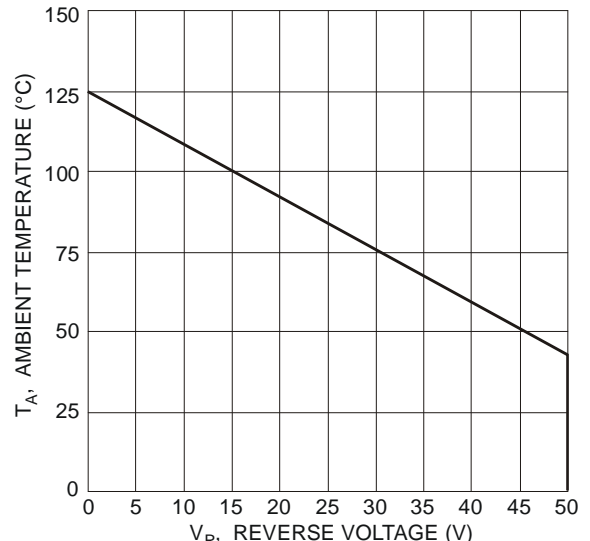


Figure 6 Operating Temperature Derating

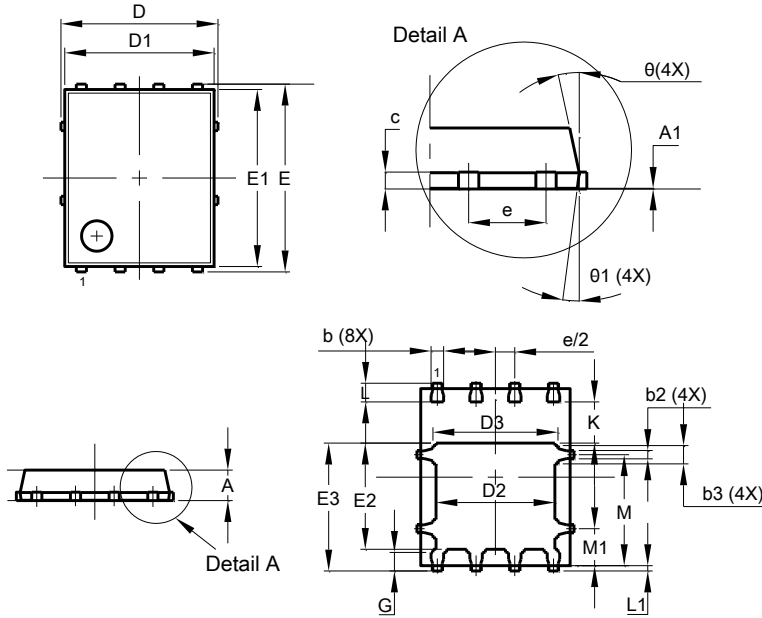
Notes:

- 7. Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.
- 8. Device mounted on aluminum substrate PC board with 2-inch sq. copper pad + additional heatsink (Al 48mm x 35mm x 80mm).

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5060-8**

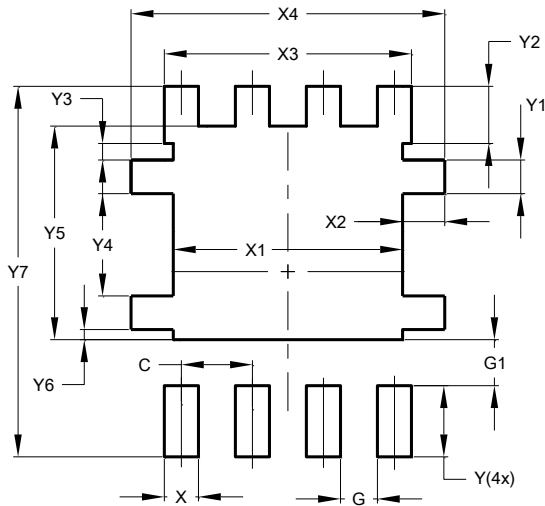


PowerDI5060-8			
Dim	Min	Max	Typ
A	0.90	1.10	1.00
A1	0.00	0.05	—
b	0.33	0.51	0.41
b2	0.200	0.350	0.273
b3	0.40	0.80	0.60
c	0.230	0.330	0.277
D	5.15 BSC		
D1	4.70	5.10	4.90
D2	3.70	4.10	3.90
D3	3.90	4.30	4.10
E	6.15 BSC		
E1	5.60	6.00	5.80
E2	3.28	3.68	3.48
E3	3.99	4.39	4.19
e	1.27 BSC		
g	0.51	0.71	0.61
K	0.51	—	—
L	0.51	0.71	0.61
L1	0.100	0.200	0.175
M	3.235	4.035	3.635
M1	1.00	1.40	1.21
theta	10°	12°	11°
theta1	6°	8°	7°
<b>All Dimensions in mm</b>			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5060-8**



Dimensions	Value (in mm)
C	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

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